

# Hyper ARGUS® LED

## Hyper-Bright, 3mm (T1) LED, Non Diffused

LS K376, LA K376, LO K376, LY K376



### Besondere Merkmale

- **Gehäusetyyp:** nicht eingefärbtes, klares 3 mm (T1) Gehäuse mit spezieller Linse
- **Besonderheit des Bauteils:** mit Einsatz eines äußeren Reflektors zur Hinterleuchtung von Lichtfeldern und LCD-Anzeigen; Lötspieße mit Aufsetzebene
- **Wellenlänge:** 632 nm (super-rot), 615 nm (amber), 605 nm (orange), 587 nm (gelb)
- **Abstrahlwinkel:** angepasst an Einsatz mit äußerem Reflektor, siehe Diagramm
- **Technologie:** InGaAlP
- **optischer Wirkungsgrad:** 11 lm/W (gelb, orange, amber), 7 lm/W (super-rot)
- **Gruppierungsparameter:** Lichtstrom
- **Lötmethode:** Wellenlöten (TTW)
- **Verpackung:** Schüttgut, gegurtet lieferbar

### Anwendungen

- Hinterleuchtung (LCD, Schalter, Tasten, Displays, Werbebeleuchtung, Allgemeinbeleuchtung)
- Innenbeleuchtung im Automobilbereich (z.B. Instrumentenbeleuchtung, u.ä.)
- Einkopplung in Lichtleiter

### Features

- **package:** colorless, clear 3 mm (T1) package with specially shaped lens
- **feature of the device:** for backlighting and LCDs with use of a reflector; solder leads with stand-off
- **wavelength:** 632 nm (super-red), 615 (amber), 605 nm (orange), 587 nm (yellow)
- **viewing angle:** matched to use with external reflector, see diagram
- **technology:** InGaAlP
- **optical efficiency:** 11 lm/W (yellow, orange, amber), 7 lm/W (super-red)
- **grouping parameter:** luminous flux
- **soldering methods:** TTW soldering
- **packing:** bulk, available taped on reel

### Applications

- backlighting (LCD, switches, keys, displays, illuminated advertising, general lighting)
- interior automotive lighting (e.g. dashboard backlighting, etc.)
- coupling into light guides

## LS K376, LA K376, LO K376, LY K376,

Typ Type	Emissions- farbe Color of Emission	Gehäusefarbe Color of Package	Lichtstrom Luminous Flux $I_F = 20 \text{ mA}$ $\Phi_V \text{ (mlm)}$	Bestellnummer Ordering Code
LS K376-QT LS K376-R LS K376-S LS K376-T LS K376-RU	super-red	colorless clear	71 ... 450 112 ... 180 180 ... 280 280 ... 450 112 ... 710	Q62703-Q3467 Q62703-Q3468 Q62703-Q3469 Q62703-Q3470 Q62703-Q3471
LA K376-RU LA K376-S LA K376-T LA K376-U LA K376-SV	amber	colorless clear	112 ... 710 180 ... 280 280 ... 450 450 ... 710 180 ... 1120	Q62703-Q3735 Q62703-Q3737 Q62703-Q3738 Q62703-Q3739 Q62703-Q3736
LO K376-RU LO K376-S LO K376-T LO K376-U LO K376-SV	orange	colorless clear	112 ... 710 180 ... 280 280 ... 450 450 ... 710 180 ... 1120	Q62703-Q3472 Q62703-Q3473 Q62703-Q3474 Q62703-Q3475 Q62703-Q3476
LY K376-RU LY K376-S LY K376-T LY K376-U LY K376-SV	yellow	colorless clear	112 ... 710 180 ... 280 280 ... 450 450 ... 710 180 ... 1120	Q62703-Q3477 Q62703-Q3478 Q62703-Q3479 Q62703-Q3480 Q62703-Q3481

Helligkeitswerte werden mit einer Stromeinprägedauer von 25 ms und einer Genauigkeit von  $\pm 11 \%$  ermittelt.  
Luminous intensity is tested at a current pulse duration of 25 ms and a tolerance of  $\pm 11 \%$ .

*Anm.: Die Standardlieferform von Serientypen beinhaltet eine untere bzw. eine obere Familiengruppe oder mindestens zwei Einzelgruppen.*

*In einer Verpackungseinheit / Gurt ist immer nur eine Helligkeitsgruppe enthalten.*

*Die technologiebedingte Helligkeits-Streuung der heutigen LED-Herstellprozesse über einen längeren Fertigungszeitraum (Halbleitermaterial - Chipherstellung - Montageprozess) erlaubt keine Zusage einer einzelnen Helligkeitsgruppe. Daher müssen mindestens zwei Helligkeitsgruppen vorgesehen werden!*

*Note: The standard shipping format for serial types includes a lower or upper family group or at least two individual groups.*

*No packing unit / tape ever contains more than one luminous intensity group.*

*Luminosity variations caused by the technology used in current LED manufacturing processes over a protracted manufacturing period (semiconductor material - chip fabrication - assembly process) mean that it is not possible to assign LEDs to a single luminous intensity group. For this reason at least two luminous intensity groups must be provided!*

**Grenzwerte**  
**Maximum Ratings**

Bezeichnung Parameter	Symbol Symbol	Werte Values		Einheit Unit
		LS, LO, LA	LY	
Betriebstemperatur Operating temperature range	$T_{op}$	- 55 ... + 100		°C
Lagertemperatur Storage temperature range	$T_{stg}$	- 55 ... + 100		°C
Sperrschichttemperatur Junction temperature	$T_j$	+ 100		°C
Durchlassstrom Forward current	$I_F$	30		mA
Stoßstrom Surge current $t \leq 10 \mu s, D = 0.005$	$I_{FM}$	1	0.2	A
Sperrspannung Reverse voltage	$V_R$	3		V
Leistungsaufnahme Power consumption $T_A \leq 25 \text{ °C}$	$P_{tot}$	80		mW
Wärmewiderstand Thermal resistance Sperrschicht/Umgebung Junction/ambient	$R_{th JA}$	500		K/W
Sperrschicht/Löt看 Junction/solder point Montage auf PC-Board FR 4 (Padgröße $\geq 16 \text{ mm}^2$ ) mounted on PC board FR 4 (pad size $\geq 16 \text{ mm}^2$ ) Minimale Beinchenlänge Minimum lead length	$R_{th JS}$	280		K/W

**Kennwerte** ( $T_A = 25\text{ °C}$ )

**Characteristics**

Bezeichnung Parameter	Symbol Symbol	Werte Values				Einheit Unit
		LS	LA	LO	LY	
Wellenlänge des emittierten Lichtes (typ.) Wavelength at peak emission $I_F = 20\text{ mA}$	$\lambda_{\text{peak}}$	645	622	610	591	nm
Dominantwellenlänge (typ.) Dominant wavelength $I_F = 20\text{ mA}$	$\lambda_{\text{dom}}$	632	615	605	587	nm
Spektrale Bandbreite bei 50 % $I_{\text{rel max}}$ (typ.) Spectral bandwidth at 50 % $I_{\text{rel max}}$ $I_F = 20\text{ mA}$	$\Delta\lambda$	16	16	16	15	nm
Durchlassspannung <sup>1)</sup> (typ.) Forward voltage <sup>1)</sup> (max.) $I_F = 20\text{ mA}$	$V_F$ $V_F$	2.0 2.4	2.0 2.4	2.0 2.4	2.0 2.4	V V
Sperrstrom (typ.) Reverse current (max.) $V_R = 3\text{ V}$	$I_R$ $I_R$	0.01 10	0.01 10	0.01 10	0.01 10	$\mu\text{A}$ $\mu\text{A}$
Temperaturkoeffizient von $\lambda_{\text{peak}}$ (typ.) Temperature coefficient of $\lambda_{\text{peak}}$ $I_F = 20\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	$TC_{\lambda_{\text{peak}}}$	0.14	0.13	0.13	0.13	nm/K
Temperaturkoeffizient von $\lambda_{\text{dom}}$ (typ.) Temperature coefficient of $\lambda_{\text{dom}}$ $I_F = 20\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	$TC_{\lambda_{\text{dom}}}$	0.01	0.06	0.07	0.10	nm/K
Temperaturkoeffizient von $V_F$ (typ.) Temperature coefficient of $V_F$ $I_F = 20\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	$TC_V$	-2.0	-1.8	-1.7	-2.5	mV/K
Optischer Wirkungsgrad (typ.) Optical efficiency $I_F = 20\text{ mA}$	$\eta_{\text{opt}}$	7	11	11	11	lm/W

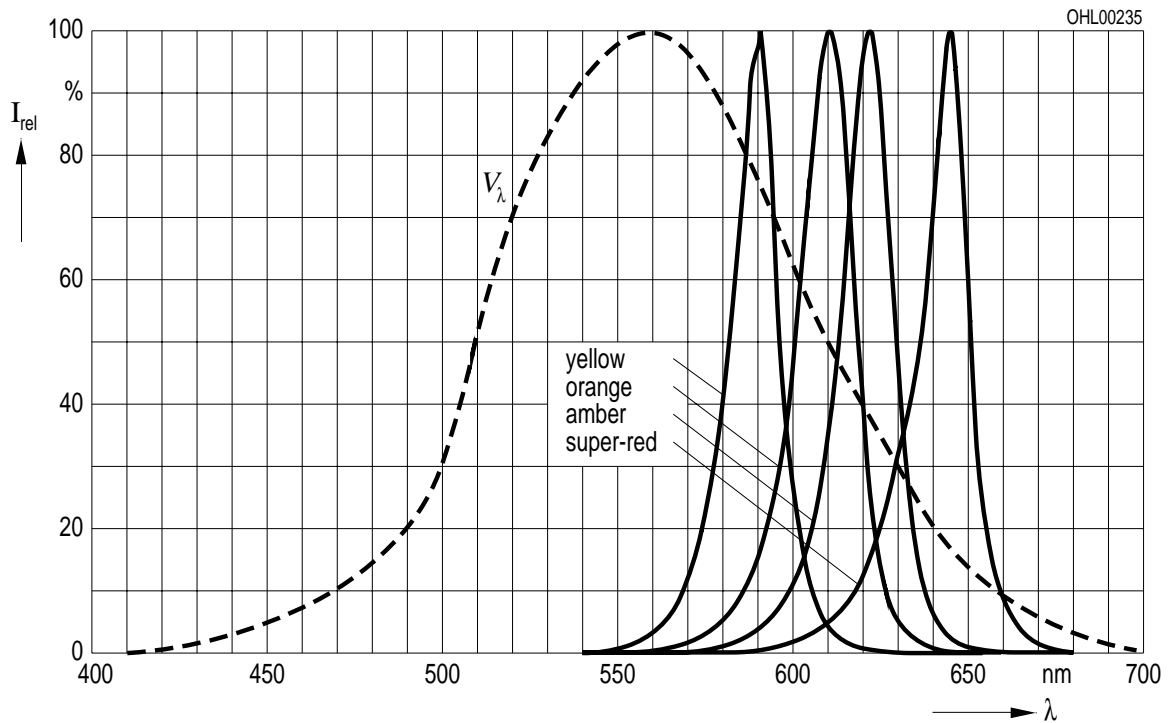
<sup>1)</sup> Spannungswerte werden mit einer Stromeinprägungsdauer von 1 ms und einer Genauigkeit von  $\pm 0.1\text{ V}$  ermittelt.  
Voltages are tested at a current pulse duration of 1 ms and a tolerance of  $\pm 0.1\text{ V}$ .

Relative spektrale Emission  $I_{rel} = f(\lambda)$ ,  $T_A = 25\text{ °C}$ ,  $I_F = 20\text{ mA}$

**Relative Spectral Emission**

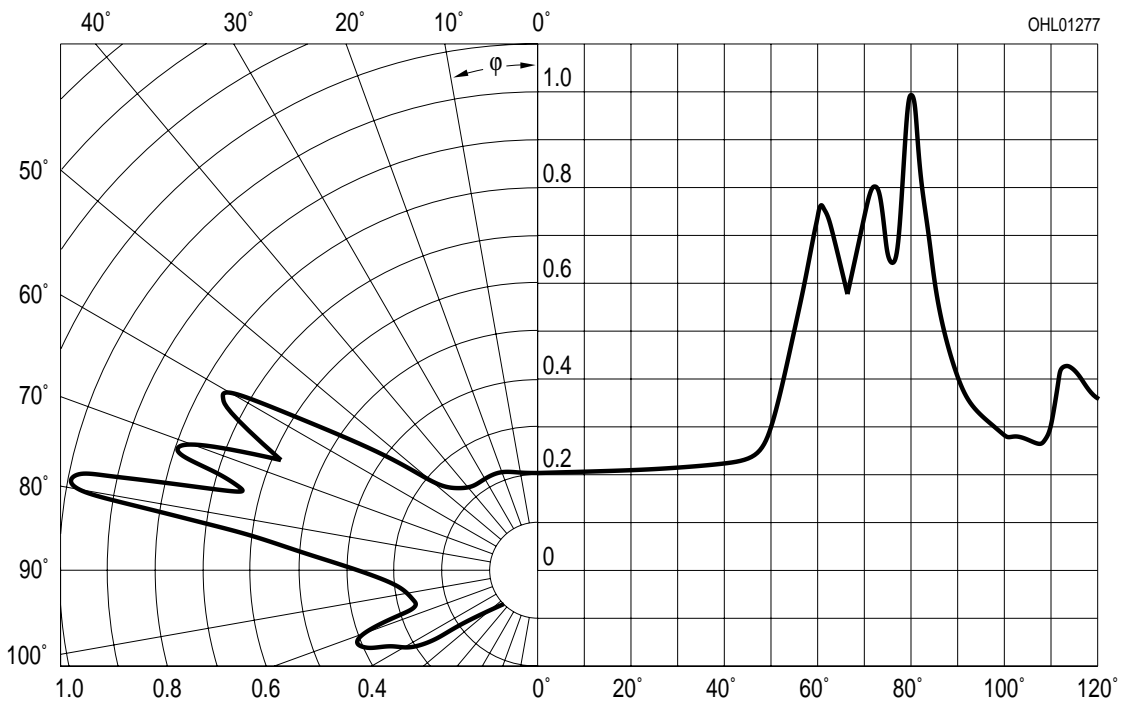
$V(\lambda)$  = spektrale Augenempfindlichkeit

Standard eye response curve



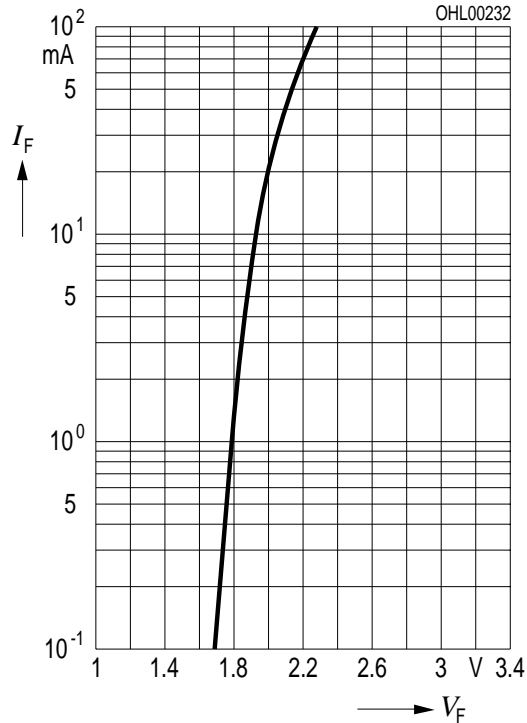
Abstrahlcharakteristik  $I_{rel} = f(\varphi)$

**Radiation Characteristic**



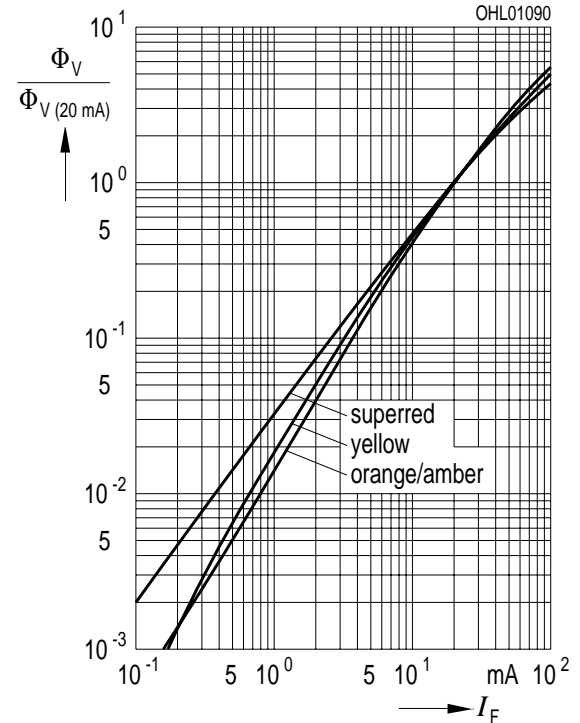
**Durchlassstrom  $I_F = f(V_F)$**   
**Forward Current**

$T_A = 25\text{ °C}$

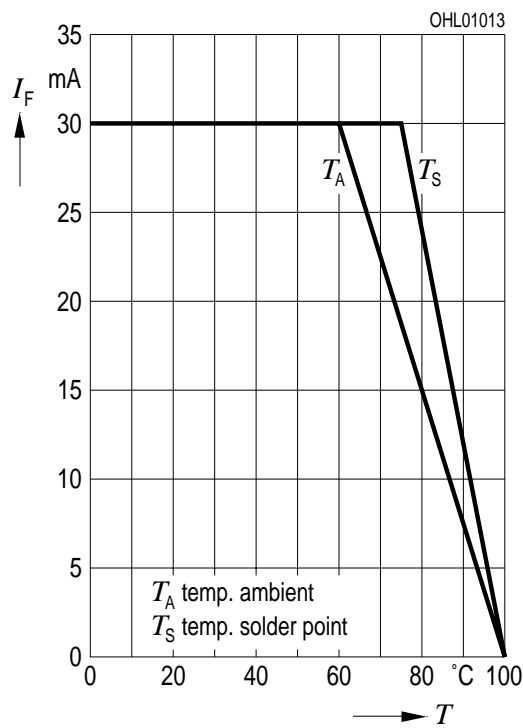


**Relativer Lichtstrom  $\Phi_V / \Phi_{V(20\text{ mA})} = f(I_F)$**   
**Relative Luminous Flux**

$T_A = 25\text{ °C}$

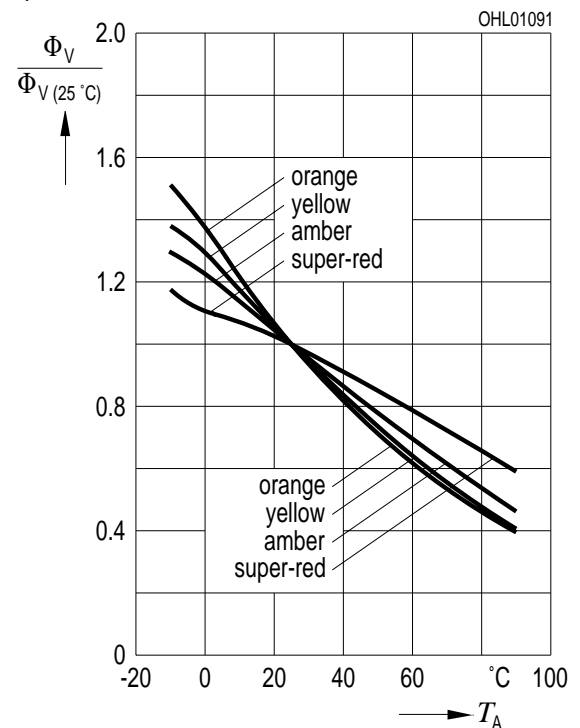


**Maximal zulässiger Durchlassstrom  $I_F = f(T)$**   
**Max. Permissible Forward Current**

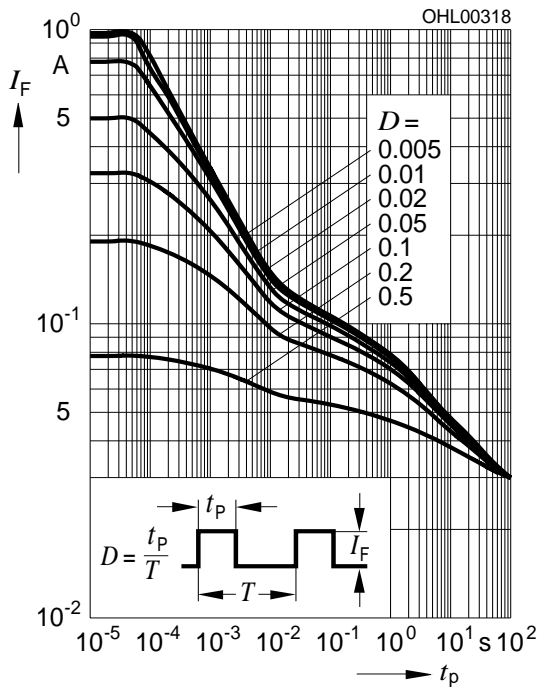


**Relativer Lichtstrom  $\Phi_V / \Phi_{V(25\text{ °C})} = f(T_A)$**   
**Relative Luminous Flux**

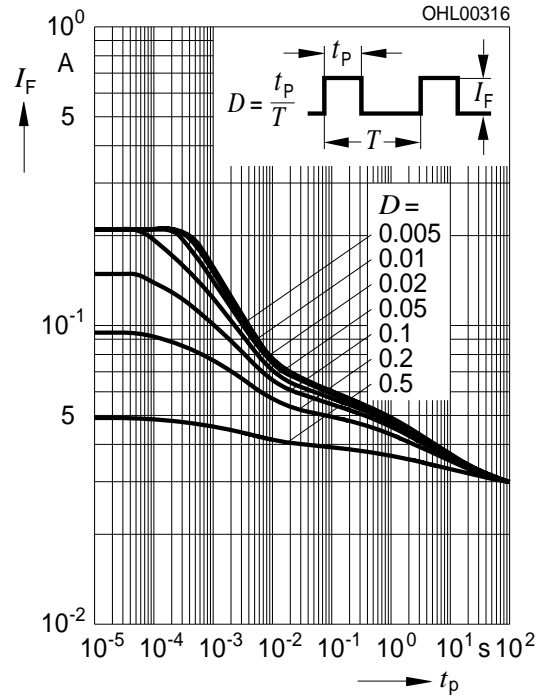
$I_F = 20\text{ mA}$



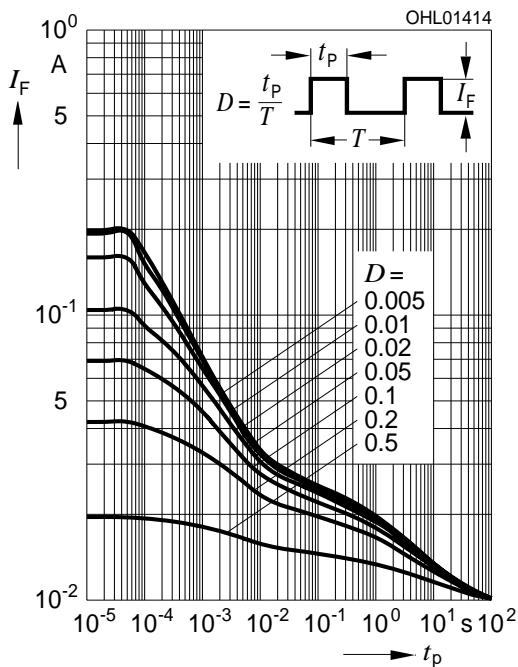
**Zulässige Impulsbelastbarkeit  $I_F = f(t_p)$**   
**Permissible Pulse Handling Capability**  
 Duty cycle  $D =$  parameter,  $T_A = 25\text{ °C}$   
**LS, LA, LO**



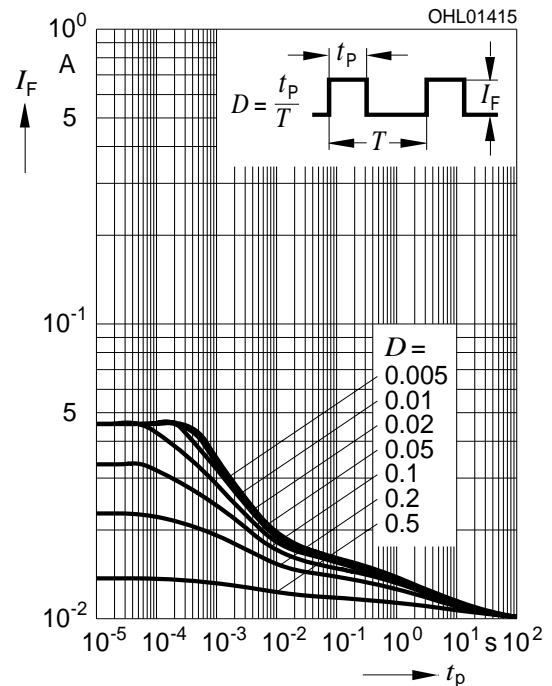
**Zulässige Impulsbelastbarkeit  $I_F = f(t_p)$**   
**Permissible Pulse Handling Capability**  
 Duty cycle  $D =$  parameter,  $T_A = 25\text{ °C}$   
**LY**



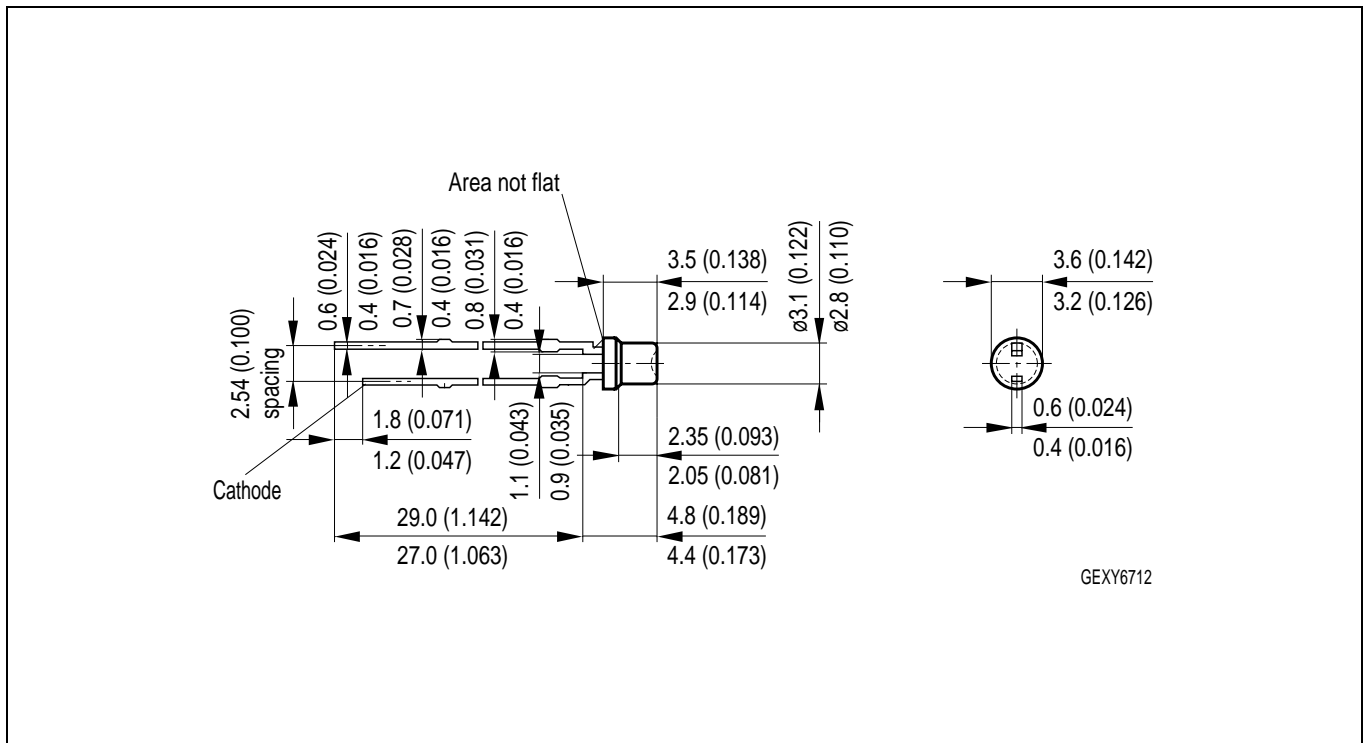
**Zulässige Impulsbelastbarkeit  $I_F = f(t_p)$**   
**Permissible Pulse Handling Capability**  
 Duty cycle  $D =$  parameter,  $T_A = 85\text{ °C}$   
**LS, LA, LO**



**Zulässige Impulsbelastbarkeit  $I_F = f(t_p)$**   
**Permissible Pulse Handling Capability**  
 Duty cycle  $D =$  parameter,  $T_A = 85\text{ °C}$   
**LY**



**Maßzeichnung**  
**Package Outlines**



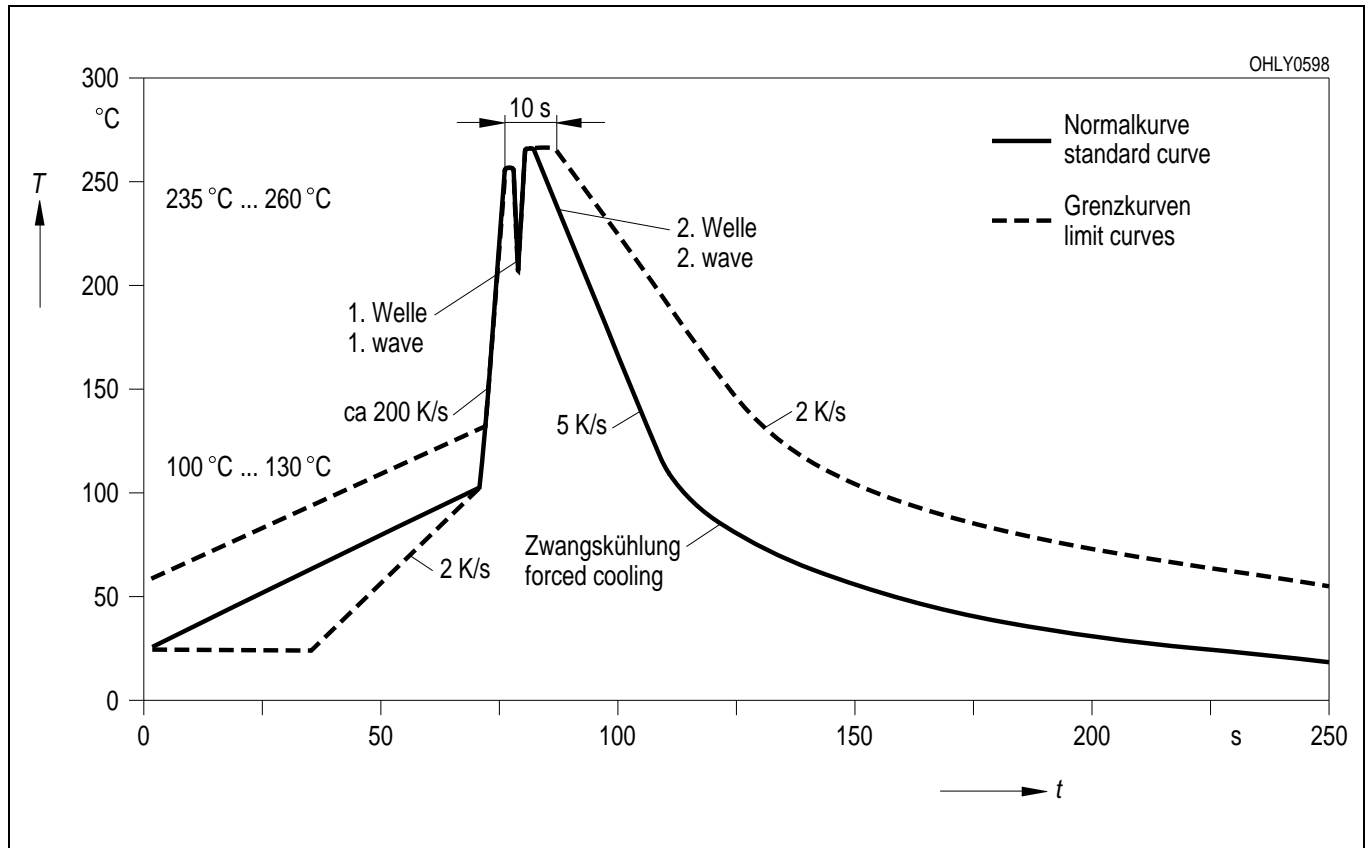
Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

**Kathodenkennung:** kürzerer Lötspieß  
**Cathode mark:** short solder lead  
**Gewicht / Approx. weight:** 160 mg

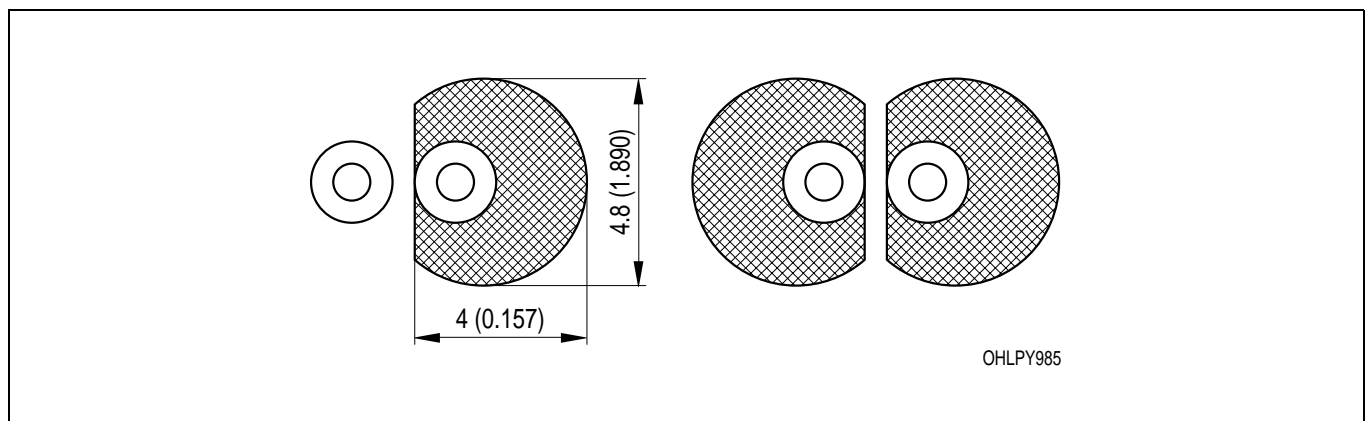


**Lötbedingungen**  
**Soldering Conditions**

**Wellenlöten (TTW)** (nach CECC 00802)  
**TTW Soldering** (acc. to CECC 00802)



**Empfohlenes Lötpaddesign** Wellenlöten (TTW)  
**Recommended Solder Pad** TTW Soldering



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch)

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**Revision History: 2001-02-13**

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Page	Subjects (major changes since last revision)

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